Features:

- Compliant with Specifications for IEEE802.3Z
- Multi-Source Package with Duplex LC Connector
- Up to 1.25Gb/s Data Links
- Single Mode 1310 DFB-LD
- Single +3.3V Power Supply
- Hot-Pluggable
- Compliant with Bellcore TA-NWT-000983
- Eye Safety Designed to Meet Laser Class1, Compliant with IEC60825-1
- RoHS Compliant Products Available

Applications:

- Gigabit Ethernet
- 1x Fiber Channel
- Switch to Switch Interface
- Switched Backplane Applications
- Router/Server Interface
- Other Optical Links

Specification:

Electrical and Optical Characteristics: (Condition: $T_a=T_{OP}$)

Parameter	Symbol	Min.	Typical	Max.	Unit
Transmitter Differential Input Volt	+/-TX_DAT	200		2400	mV p-p
Supply Current	I_{CC}		130	180	mA
Tx_Disable Input Voltage – Low	V_{IL}	0		0.8	V
Tx_Disable Input Voltage – High	V_{IH}	2.0		Vcc	V
Tx_Fault Output Voltage – Low	V_{OL}	0		0.8	V
Tx_Fault Output Voltage – High	V_{OH}	2.0		Vcc	V
Receiver Differential Output Volt	+/-RX_DAT	600		1400	mV p-p
Rx_LOS Output Voltage- Low	V_{OL}	0		0.8	V
Rx_LOS Output Voltage- High	V_{OH}	2.0		Vcc	V

Transmitter

Parameter	Symbol	Min.	Typical	Max.	Unit
Data Rate	B	-	1250	-	Mb/s
Centre Wavelength	λ c	1296	1310	1330	nm
Output Spectral Width(	$\triangle \lambda$	-	-	1	nm
Average Output Power	P_o	-5	-	0	dBm
Extinction Ratio	EXT	9	-	-	dB
Data Input Voltage-High	V_{IHS}	V_{cc}-1.16	-	V_{cc}-0.89	V
Data Input Voltage -Low	V_{ILS}	V_{cc}-1.82	-	V_{cc}-1.48	V
Supply Current	I_{CC}	-	90	150	mA
Output Optical Eye	Compliant with IEEE802.3Z				

Receiver					
Parameter	**Symbol**	**Min.**	**Typical**	**Max.**	**Unit**
Receive Sensitivity	P_{min}	-	-	-23	dBm
Maximum Input Power	P_{MAX}	-3	-	-	dBm
Threshold-Assertion:	SD_{HIGH}	-	-	-24	dBm
Signal Detect Threshold-Deassertion:	SD_{LOW}	-34	-	-	dBm
Hysteresis	-	-	2.0	-	dBm
Output High Voltage	V_{OH}	V_{cc}-1.03	-	V_{cc}-0.89	V
Output Low Voltage	V_{OL}	V_{cc}-1.82	-	V_{cc}-1.63	V
Operating Wavelength	λ c	1100	-	1600	nm
Supply Current	I_{CC}	-	80	110	mA

l Absolute Maximum Ratings: (T_C=25℃)

Parameter	Symbol	Min.	Max.	Unit
Storage Temperature	T_{ST}	-40	+85	℃
Operating Temperature	T_{IP}	0	+70	℃
Input Voltage	T_{CC}	0	+5	V

l Recommended Operating Environment:

Parameter	Symbol	Min.	Typical	Max.	Unit
Supply Voltage	V_{CC}	+3.0	+3.3	+3.6	V
Operating Temperature	T_{OP}	0	-	+70	℃

l Timing Characteristics:

Parameter	Symbol	Min.	Typical	Max.	Unit
TX_DISABLE Assert Time	t_off		3	10	usec
TX_DISABLE Negate Time	t_on		0.5	1	msec
Time to initialize include reset of TX_FAULT	t_int		30	300	msec
TX_FAULT from fault to assertion	t_fault		20	100	usec
TX_DISBEL time to start reset	t_reset	10			usec
Receiver Loss of Signal Assert Time (off to On)	T_A,RX_LOS			100	usec
Receiver Loss of Signal Assert Time (on to off)	T_d,RX_LOS			100	usec

l Digital Diagnostic Monitor Characteristics:

Parameter	Min.	Unit
Tx Output Power Accuracy	±3.0	dBm
Rx Input Power Accuracy	±3.0	dBm

Laser Bias Current Accuracy	±1 0	%
Transceiver Internal Temperature Accuracy	±3.0	° C
Transceiver Internal Supply Voltage Accuracy	±0.1	V

Serial ID Memory Contents:

Data Address	Length (Byte)	Name of Length	Description and Contents
Base ID Fields			
0	1	Identifier	Type of Serial transceiver (03h=SFP)
1	1	Reserved	Extended identifier of type serial transceiver (04h)
2	1	Connector	Code of optical connector type (07=LC)
3-10	8	Transceiver	Gigabit Ethernet 1000Base-SX & Fiber Channel
11	1	Encoding	8B10B (01h)
12	1	BR,Nominal	Nominal baud rate, unit of 100Mbps
13-14	2	Reserved	(0000h)
15	1	Length(9um)	Link length supported for 9/125um fiber, units of 100m
16	1	Length(50um)	Link length supported for 50/125um fiber, units of 10m
17	1	Length(62.5um)	Link length supported for 62.5/125um fiber, units of 10m
18	1	Length(Copper)	Link length supported for copper, units of meters
19	1	Reserved	
20-35	16	Vendor Name	SFP vendor name: TINOUT
36	1	Reserved	
37-39	3	Vendor OUI	SFP transceiver vendor OUI ID
40-55	16	Vendor PN	Part Number: “PTPxxxxxx” (ASCII)
56-59	4	Vendor rev	Revision level for part number
60-62	3	Reserved	
63	1	CCID	Least significant byte of sum of data in address 0-62
Extended ID Fields			
64-65	2	Option	Indicates which optical SFP signals are implemented (001Ah = LOS, TX_FAULT, TX_DISABLE all supported)
66	1	BR, max	Upper bit rate margin, units of %
67	1	BR, min	Lower bit rate margin, units of %
68-83	16	Vendor SN	Serial number (ASCII)
84-91	8	Date code	TINOUT ’s Manufacturing date code
92-94	3	Reserved	
95	1	CCEX	Check code for the extended ID Fields (addresses 64 to 94)
Vendor Specific ID Fields			
96-127	32	Readable	TINOUT specific date, read only

Serial ID Memory Contents: (A2H)

Address	# Bytes	Name	Description
00-01	2	Temp High Alarm	MSB at low address
02-03	2	Temp Low Alarm	MSB at low address
04-05	2	Temp High Warning	MSB at low address
06-07	2	Temp Low Warning	MSB at low address
08-09	2	Voltage High Alarm	MSB at low address

10-11	2	Voltage Low Alarm	MSB at low address
12-13	2	Voltage High Warning	MSB at low address
14-15	2	Voltage Low Warning	MSB at low address
16-17	2	Bias High Alarm	MSB at low address
18-19	2	Bias Low Alarm	MSB at low address
20-21	2	Bias High Warning	MSB at low address
22-23	2	Bias Low Warning	MSB at low address
24-25	2	TX Power High Alarm	MSB at low address
26-27	2	TX Power Low Alarm	MSB at low address
28-29	2	TX Power High Warning	MSB at low address
30-31	2	TX Power Low Warning	MSB at low address
32-33	2	RX Power High Alarm	MSB at low address
34-35	2	RX Power Low Alarm	MSB at low address
36-37	2	RX Power High Warning	MSB at low address
38-39	2	RX Power Low Warning	MSB at low address
40-55	16	Reserved	Reserved for future monitored quantities

Address	# Bytes	Name	Description
56-59	4	Rx_PWR(4)	Single precision floating point calibration data - Rx optical power. Bit 7 of byte 56 is MSB. Bit 0 of byte 59 is LSB.
60-63	4	Rx_PWR(3)	Single precision floating point calibration data - Rx optical power. Bit 7 of byte 60 is MSB. Bit 0 of byte 63 is LSB.
64-67	4	Rx_PWR(2)	Single precision floating point calibration data - Rx optical power. Bit 7 of byte 64 is MSB, bit 0 of byte 67 is LSB.
68-71	4	Rx_PWR(1)	Single precision floating point calibration data - Rx optical power. Bit 7 of byte 68 is MSB, bit 0 of byte 71 is LSB.
72-75	4	Rx_PWR(0)	Single precision floating point calibration data - Rx optical power. Bit 7 of byte 72 is MSB, bit 0 of byte 75 is LSB.
76-77	2	Tx_I(Slope)	Fixed decimal (unsigned) calibration data, laser bias current. Bit 7 of byte 76 is MSB, bit 0 of byte 77 is LSB.
78-79	2	Tx_I(Offset)	Fixed decimal (signed two's complement) calibration data, laser bias current. Bit 7 of byte 78 is MSB, bit 0 of byte 79 is LSB
80-81	2	Tx_PWR(Slope)	Fixed decimal (unsigned) calibration data, transmittercoupled output power. Bit 7 of byte 80 is MSB, bit 0 of byte81 is LSB.
82-83	2	Tx_PWR(Offset)	Fixed decimal (signed two's complement) calibration data, transmitter coupled output power. Bit 7 of byte 82 is MSB, bit 0 of byte 83 is LSB.
84-85	2	T(Slope)	Fixed decimal (unsigned) calibration data, internal module temperature. Bit 7 of byte 84 is MSB, bit 0 of byte 85 is LSB.
86-87	2	T(Offset)	Fixed decimal (signed two's complement) calibration data, internal module temperature. Bit 7 of byte 86 is MSB, bit 0 of byte 87 is LSB.

88-89	2	V(Slope)	Fixed decimal (unsigned) calibration data, internal module supply voltage. Bit 7 of byte 88 is MSB, bit 0 of byte 89 is LSB.
90-91	2	V(Offset)	Fixed decimal (signed two's complement) calibration data, internal module supply voltage. Bit 7 of byte 90 is MSB. Bit 0 of byte 91 is LSB.
92-95	4	Reserved	Reserved

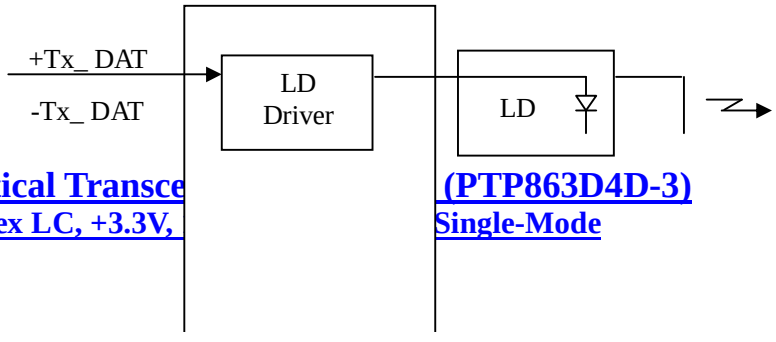
Byte	Bit	Name	Description
Converted analog values. Calibrated 16 bit data			
96	All	Temperature MSB	Internally measured module temperature.
97	All	Temperature LSB	
98	All	Vcc MSB	Internally measured supply voltage in transceiver.
99	All	Vcc LSB	
100	All	TX Bias MSB	Internally measured TX Bias Current.
101	All	TX Bias LSB	
102	All	TX Power MSB	Measured TX output power.
103	All	TX Power LSB	
104	All	RX Power MSB	Measured RX input power.
105	All	RX Power LSB	
106	All	Reserved MSB	Reserved for 1st future definition of digitized analog input
107	All	Reserved LSB	Reserved for 1st future definition of digitized analog input
108	All	Reserved MSB	Reserved for 2nd future definition of digitized analog input
109	All	Reserved LSB	Reserved for 2nd future definition of digitized analog input
Optional Status/Control Bits			
110	7	TX Disable State	Digital state of the TX Disable Input Pin. Not supported.
110	6	Soft TX Disable	Read/write bit that allows software disable of laser. Not supported.
110	5	Reserved	
110	4	RX Rate Select State	Digital state of the SFP RX Rate Select Input Pin. Not supported.
110	3	Soft RX Rate Select	Read/write bit that allows software RX rate select.
			Not supported.
110	2	TX Fault	Digital state of the TX Fault Output Pin.
110	1	LOS	Digital state of the LOS Output Pin.
110	0	Data Ready	Indicates transceiver has achieved power up and data is ready
111	7-0	Reserved	Reserved.

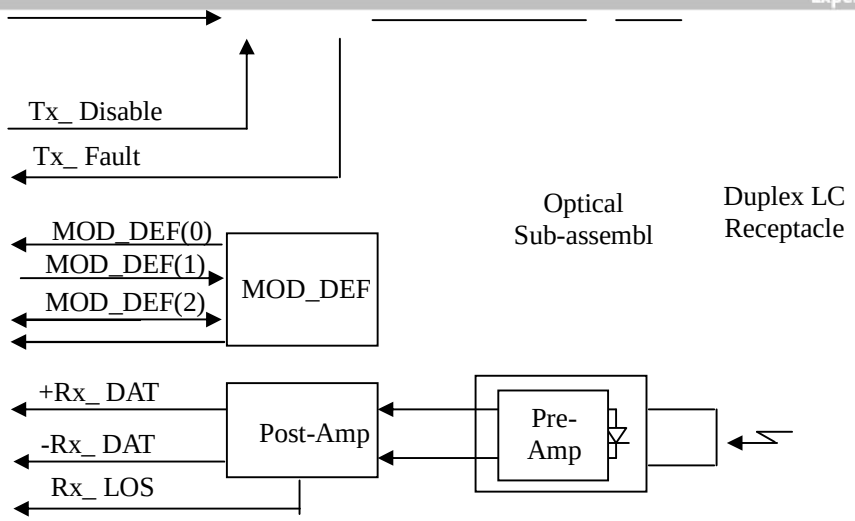
Byte	Bit	Name	Description
Reserved Optional Alarm and Warning Flag Bits			
112	7	Temp High Alarm	Set when internal temperature exceeds high alarm level.
112	6	Temp Low Alarm	Set when internal temperature is below low alarm level.
112	5	Vcc High Alarm	Set when internal supply voltage exceeds high alarm level.
112	4	Vcc Low Alarm	Set when internal supply voltage is below low alarm level.
112	3	TX Bias High Alarm	Set when TX Bias current exceeds high alarm level.
112	2	TX Bias Low Alarm	Set when TX Bias current is below low alarm level.

112	1	TX Power High Alarm	Set when TX output power exceeds high alarm level.
112	0	TX Power Low Alarm	Set when TX output power is below low alarm level.
113	7	RX Power High Alarm	Set when Received Power exceeds high alarm level.
113	6	RX Power Low Alarm	Set when Received Power is below low alarm level.
113	5	Reserved Alarm	
113	4	Reserved Alarm	
113	3	Reserved Alarm	
113	2	Reserved Alarm	
113	1	Reserved Alarm	
113	0	Reserved Alarm	
114	All	Reserved	
115	All	Reserved	
116	7	Temp High Warning	Set when internal temperature exceeds high warning level.
116	6	Temp Low Warning	Set when internal temperature is below low warning level.
116	5	Vcc High Warning	Set when internal supply voltage exceeds high warning level.
116	4	Vcc Low Warning	Set when internal supply voltage is below low warning level.
116	3	TX Bias High Warning	Set when TX Bias current exceeds high warning level.
116	2	TX Bias Low Warning	Set when TX Bias current is below low warning level.
116	1	TX Power High Warning	Set when TX output power exceeds high warning level.
116	0	TX Power Low Warning	Set when TX output power is below low warning level.
117	7	RX Power High Warning	Set when Received Power exceeds high warning level.
117	6	RX Power Low Warning	Set when Received Power is below low warning level.
117	5	Reserved Warning	
117	4	Reserved Warning	
117	3	Reserved Warning	
117	2	Reserved Warning	
117	1	Reserved Warning	
117	0	Reserved Warning	
118	All	Reserved	
119	All	Reserved	

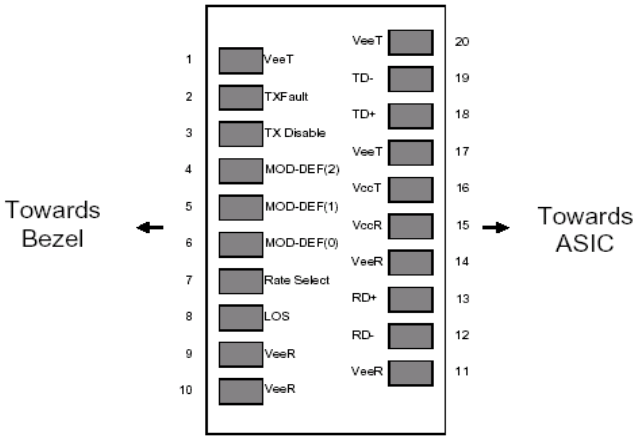
Byte	# Byte	Name	Description
120-127	8	Vendor Specific	00h.
128-255	128		Writable Memory

Block Diagram of Transceiver:





Pin Assignment:



Pin out of Connector Block on Host Board

Pin Description:

Pin	Symbol	Name/Description	Ref.
1	V_{EET}	Transmitter Ground (Common with Receiver Ground)	1
2	T_{FAULT}	Transmitter Fault. Not supported.	
3	T_{DIS}	Transmitter Disable. Laser output disabled on high or open.	2
4	MOD_DEF(2)	Module Definition 2. Data line for Serial ID.	3
5	MOD_DEF(1)	Module Definition 1. Clock line for Serial ID.	3
6	MOD_DEF(0)	Module Definition 0. Grounded within the module.	3
7	Rate Select	No connection required	
8	LOS	Loss of Signal indication. Logic 0 indicates normal operation.	4
9	V_{EER}	Receiver Ground (Common with Transmitter Ground)	1
10	V_{EER}	Receiver Ground (Common with Transmitter Ground)	1
11	V_{EER}	Receiver Ground (Common with Transmitter Ground)	1
12	RD-	Receiver Inverted DATA out. AC Coupled	
13	RD+	Receiver Non-inverted DATA out. AC Coupled	
14	V_{EER}	Receiver Ground (Common with Transmitter Ground)	1
15	V_{CCR}	Receiver Power Supply	
16	V_{CCT}	Transmitter Power Supply	
17	V_{EET}	Transmitter Ground (Common with Receiver Ground)	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled.	
19	TD-	Transmitter Inverted DATA in. AC Coupled.	
20	V_{EET}	Transmitter Ground (Common with Receiver Ground)	1

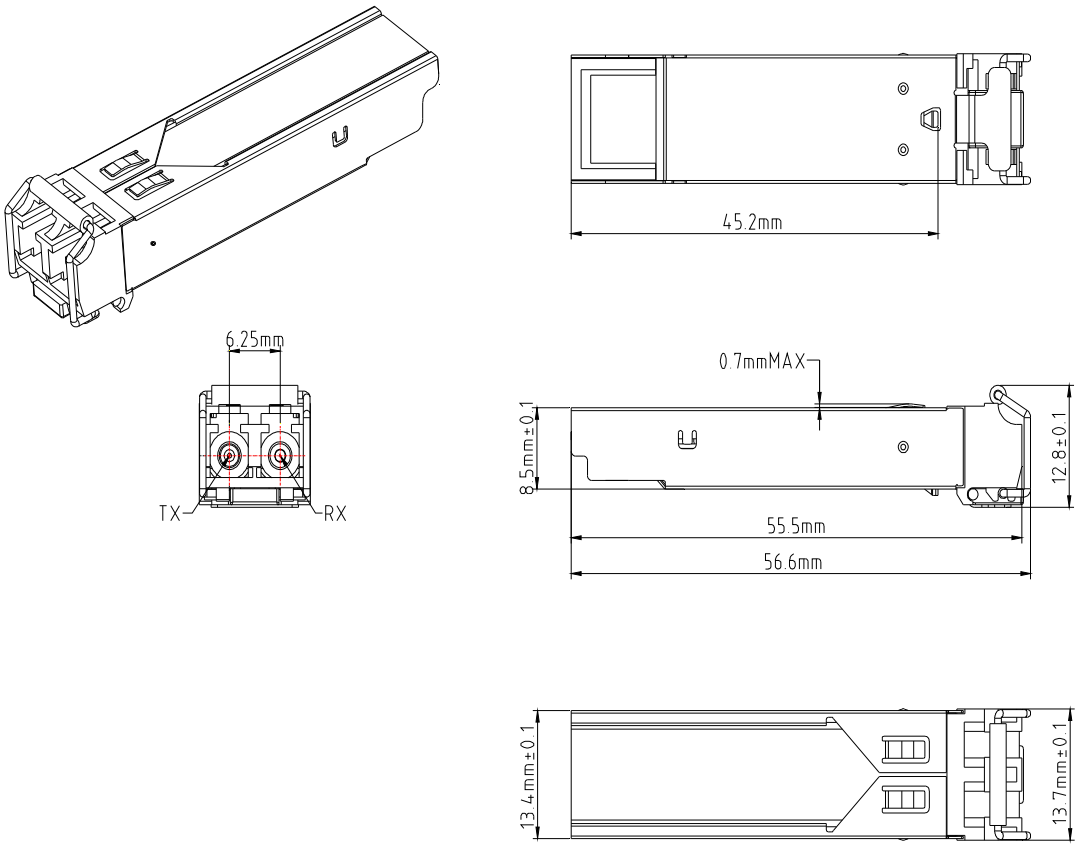
Notes:

1. Circuit ground is internally isolated from chassis ground.
2. Laser output disabled on TDIS >2.0V or open, enabled on TDIS <0.8V.
3. Should be pulled up with 4.7k – 10kohms on host board to a voltage between 2.0V and 3.6V. MOD_DEF(0) pulls line low to indicate module is plugged in.
4. LOS is open collector output. Should be pulled up with 4.7k – 10kohms on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.

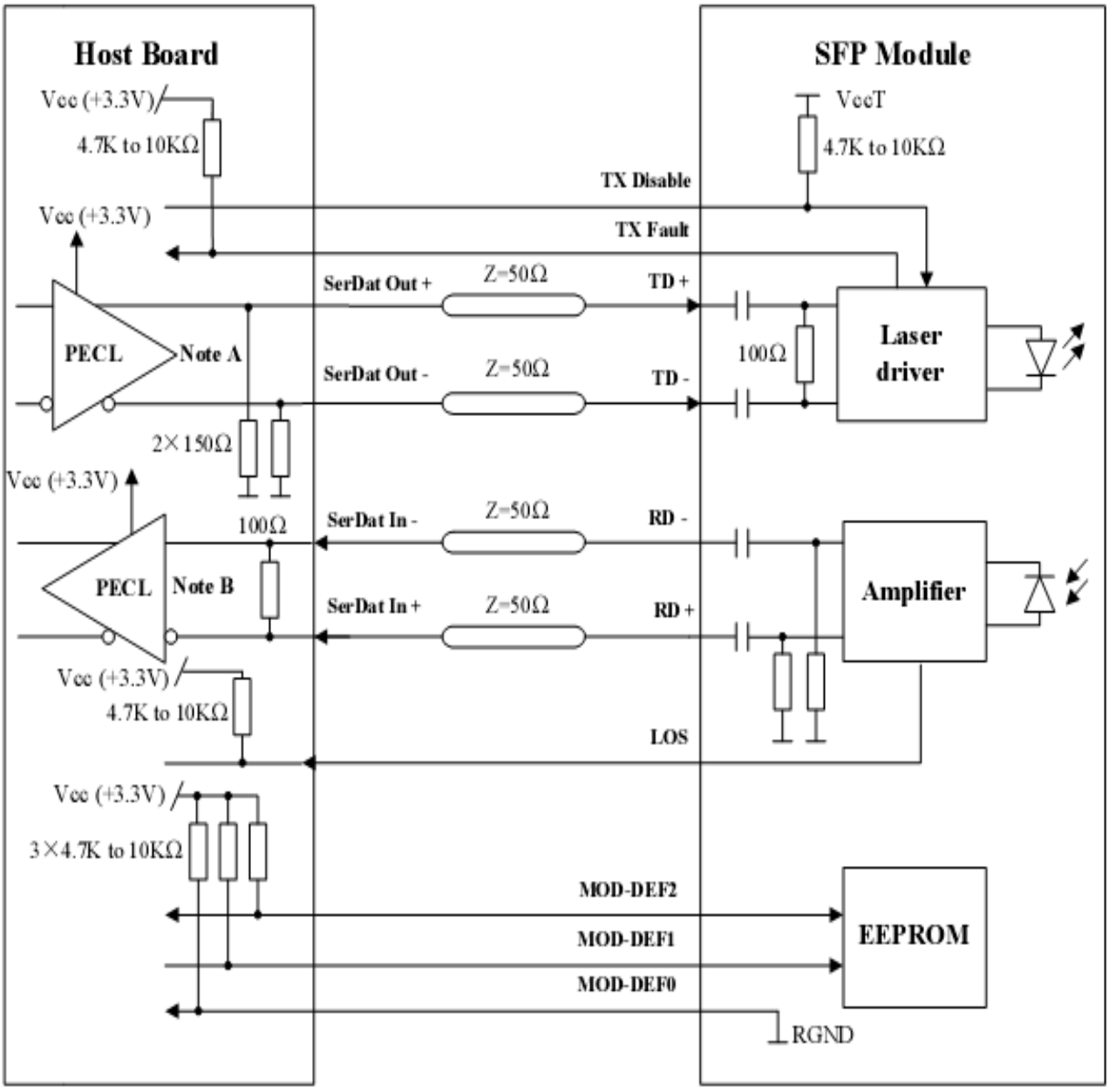
Ordering information:

Part Number	Product Description
PTP863D4-3	1310nm, 1250Mbps, LC, 40km, 0°C~+70°C
PTP863D4D-3	1310nm, 1250Mbps, LC, 40km, 0°C~+70°C, With Digital Diagnostic Monitoring
PTP863D4-3I	1310nm, 1250Mbps, LC, 40km, -40°C~+85°C
PTP863D4D-3I	1310nm, 1250Mbps, LC, 40km, -40°C~+85°C, With Digital Diagnostic Monitoring

Mechanical Dimensions:



Recommended Circuit:



Note A: Circuit assumes open emitter output

Note B: Circuit assumes high impedance internal bias @Vcc-1.3V